

REMARKS

Claims 1-5 are pending. Claim 1 has been amended. No new matter is presented.

Claims 1-4 were rejected under 35 USC 102(b) as being anticipated by Masui, U.S. Patent 5,557,116. This rejection is respectfully overcome.

Claim 1 recites "the semiconductor laser device further comprises a cover which is attached to the side face of the heat radiation block at both ends thereof." Masui fails to disclose or suggest this feature. As can be seen in Fig. 19, Masui does not teach a cover which is attached to the side face at both ends of the heat radiation block.

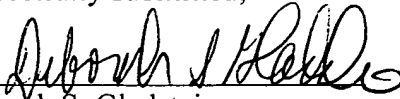
Claims 2-4 are allowable at least due to their respective dependencies. Applicant respectfully requests that this rejection be withdrawn.

Claim 5 was rejected under 35 USC 103(a) as being unpatentable over Masui. Claim 5 is allowable at least due to its dependency from claim 1. Applicant requests that this rejection be withdrawn.

In the event the U.S. Patent and Trademark office determines that an extension and/or other relief is required, applicant petitions for any required relief including extensions of time and authorizes the Commissioner to charge the cost of such petitions and/or other fees due in connection with the filing of this document to Deposit Account No. 03-1952 referencing docket no. 204552029300.

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Respectfully submitted,

By 
Deborah S. Gladstein

Registration No.: 43,636
MORRISON & FOERSTER LLP
1650 Tysons Blvd, Suite 300
McLean, Virginia 22102
(703) 760-7753